



NOTE :

1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
2. COPLANARITY APPLIES TO THE EXPOSED THERMAL PAD AS WELL AS THE TERMINALS.
3. REFER JEDEC MO-220
4. THERMAL PAD SOLDERING AREA
5. RECOMMENDED LAND PATTERN IS FOR REFERENCE ONLY.

DIODES
INCORPORATED

PERICOM
A PRODUCT LINE
OF DIODES
INCORPORATED
ENABLING SERIAL CONNECTIVITY

DATE: 09/08/16

DESCRIPTION: 54-Contact, Very Thin Quad Flat No-Lead (TQFN)

PACKAGE CODE: ZF (ZF54)

DOCUMENT CONTROL #: PD-2114

REVISION: C